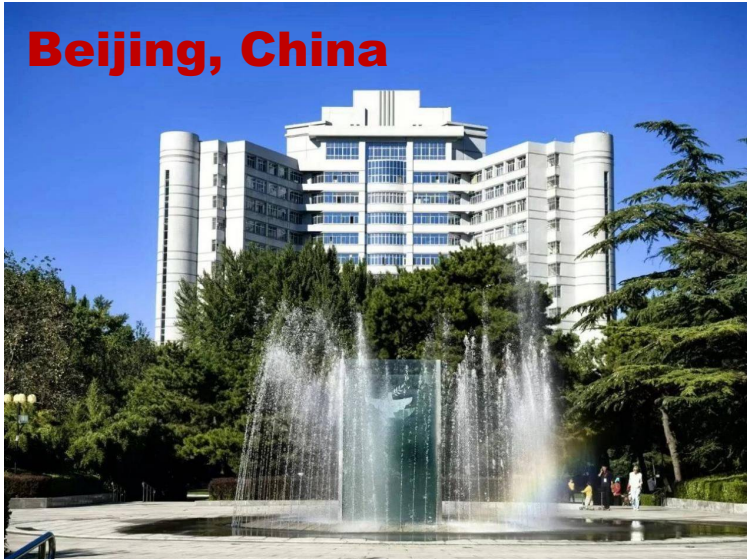




Second Announcement



11th East Asia Joint Symposium on Plasma and Electrostatic Technologies for Environmental Application (EAPETEA-11)



Beijing, China

Venue : Beijing Institute of Technology

Official website : eapetea2026.aconf.org

Online registration and abstract submission are now open!
Participants are invited to complete registration and submit a one-page A4 abstract via the official website.

Contact : eapetea11@163.com

Supported by Electrostatics Committee,
Chinese Physical Society

Welcome

It is a great honor and pleasure to invite you to participate in the “11th East Asia Joint Symposium on Plasma and Electrostatic Technologies for Environmental Application (EAPETEA-11)” to be held on **October 9-11, 2026** in **Beijing, China**. Following the first working group meeting in Jeju (November 22–24, 2012), the symposium has been successfully held annually, rotating among Korea, Japan, and China since 2017. EAPETEA has become an important platform for academic exchange and collaboration among East Asian researchers in the fields of plasma and electrostatic technologies. In this meeting, critical issues and ongoing advances in plasma science and its applications will be discussed, including but not limited to plasma diagnostics, commercial plasma technologies, and their applications in biomedical, environmental, and industrial fields. We sincerely welcome your participation in EAPETEA-11 and hope you will enjoy the rich academic atmosphere and cultural heritage of the vibrant city of Beijing. **On-site registration and check-in will be arranged on 8 October 2026, one day before the technical sessions.**

Registration Fee (Overseas Participants)

	Early (30 July)	Late
Regular	400 USD	500 USD
Student	300 USD	350 USD

Registration Fee (Domestic Participants)

	Early (30 July)	Late
Regular	2500 RMB	3000 RMB
Student	2000 RMB	2500 RMB

Important Dates

First announcement	20 March 2026
Second announcement	30 April 2026
Registration (website)	30 May 2026 - Now open
Early Payment	30 July 2026
Abstract (A4, 1 page)	15 September 2026
Final announcement	1 October 2026
On-site registration	8 October 2026

Conference Schedule

	Day-1 (9 October)	Day-2 (10 October)	Day-3 (11 October)
Time	Registration	Registration	Registration
9 00	Oral-1	Oral-4	Oral-6
10 00	Coffee Break	Coffee Break	Coffee Break
11 00	Oral-2	Oral-5	Oral-7
12 00	Group photo	Lunch	Lunch
13 00	Lunch		
14 00	Oral-3	Excursion	Oral-8
15 00			
16 00	Coffee Break		Coffee Break
17 00	Poster presentation		Oral-9
18 00			
19 00	Poster Session	Conference Dinner	
20 00			Closing

Day-2 Excursion:

A visit to the Summer Palace, followed by the conference dinner at the Friendship Hotel.

Early Payment(30 July)

Please complete online registration via the official website. After registration, the organizing committee will provide payment instructions or issue an invoice as needed.

VISA

NO VISA REQUIREMENTS FOR MANY COUNTRIES, INCLUDING JAPAN, KOREA

Venue and Conference Dinner



Hotel: The Friendship hotel is one of the best five-star hotels in Beijing and it takes about 10 min walk from the conference Venue. Details may be found via the link: [Beijing Friendship Hotel \(bjfriendshiphotel.com\)](http://bjfriendshiphotel.com). More than 20 local hotels within 10 min-walk distance to BIT campus are also very suitable for participants.

Transportation: There are many direct flights between Beijing and other Asian cities. There are good connections between the hotel and airports and/or train station. It may take about 30-40 min by taxi to the hotel, or about one hour by subway. It takes 2 min walk from the subway (Line 4) to the hotel.

International Committee Members

Akira Mizuno, Toyohashi University of Technology (JAPAN)

Atsushi Komuro, AIST (JAPAN)

Hyun-Ha Kim, AIST (JAPAN)

Nozomi Takeuchi, Institute of Science Tokyo (JAPAN)

Tomohiro Nozaki, Institute of Science Tokyo (JAPAN)

Tomoyuki Kuroki, Osaka Metropolitan University (JAPAN)

Danhua Mei, Nanjing Tech University (CHINA)

Dingxin Liu, Xi'an Jiaotong University (CHINA)

Jie Li, Dalian University of Technology (CHINA)

Keping Yan, Zhejiang University (CHINA)

Nan Jiang, Dalian University of Technology (CHINA)

Tao Shao, China Academy of Science (CHINA)

Dae-Hoon Lee, Korea Institute of Machinery & Materials (KOREA)

Helena Li, Pusan National University (KOREA)

Jungho Hwang, Yeonsei University (KOREA)

WooSeok Kang, Korea Institute of Machinery & Materials (KOREA)

Young-Hoon Song, Korea Institute of Machinery & Materials (KOREA)

Local Organizing Committee Members

Honorary Chairmen: Shang He Liu (刘尚合), Zhong Guang Bao (鲍重光)

Chairman: Jiting Ouyang (欧阳吉庭), Beijing Institute of Technology, jtouyang@bit.edu.cn

Co-chairman: Keping Yan, Zhejiang University (kyan@zju.edu.cn)

Secretary: Bocong Zheng (郑博聪), Beijing Institute of Technology, zheng@bit.edu.cn

Bing Sun (孙冰), Dalian Maritime University (sunb88@dlnu.edu.cn)

Changjiang Ding (丁昌江), Inner Mongolia University of Technology (ding9713@imut.edu.cn)

Cheng Zhang (章程), Institute of Electrical Engineering, Chinese Academy of Sciences (zhangcheng@mail.iee.ac.cn)

Danhua Mei (梅丹华), Nanjing Tech University (danhuamei@njtech.edu.cn)

Dingxin Liu (刘定新), Xi'an Jiaotong University (liudingxin@mail.xjtu.edu.cn)

Fada Feng (冯发达), Jiaying University (fadafeng@jyu.edu.cn)

Feng Yu (于锋), Shihezi University (yufeng05@mail.ipc.ac.cn)

Hao Zhang (张浩), Zhejiang University (zhang_hao@zju.edu.cn)

Jian Wu (吴健), Harbin Institute of Technology (jian.wu@hit.edu.cn)

Jiancheng Wang (王建成), Taiyuan University of Technology (wangjiancheng@tyut.edu.cn)

Jing Zhang (张菁), Donghua University (jingzh@dhu.edu.cn)

Junke Zhao (赵君科), Entech (481979296@qq.com)

Guan-Jun Zhang (张冠军), Xi'an Jiaotong University (gjzhang@xjtu.edu.cn)

Lanbo Di (底兰波), Dalian University (dilanbo@dlu.edu.cn)

Minggong Chen (陈明功), Anhui University Science and Technology (mgchen@aust.edu.cn)

Nan Jiang (姜楠), Dalian University of Technology (jiangnan@dlut.edu.cn)

Rong Gang Wang (王荣刚), Canmax Technologies Co., Ltd. (wangronggang@canmax.com.cn)

Ruobing Zhang (张若兵), Tsinghua Shenzhen International Graduate School (zhangrb@sz.tsinghua.edu.cn)

Shuiliang Yao (姚水良), Changzhou University (yaos@cczu.edu.cn)

Local Organizing Committee Members (continued)

Tao Shao(邵涛), Institute of Electrical Engineering, Chinese Academy of Sciences (shaotao1977@foxmail.com)

Tao Zhu (竹涛), China University of Mining & Technology-Beijing (bamboozt@cumtb.edu.cn)

Weizong Wang (王伟宗), Beihang University (wangweizong@buaa.edu.cn)

Xuekai Pei (裴学凯), Wuhan University (peixuekai@whu.edu.cn)

Xuming Zhang (章旭明), Zhejiang Sci-Tech University (xuming.zhang@zstu.edu.cn)

Yanan Liu (刘亚男), Donghua University (liuyanan@dhu.edu.cn)

Yangyang Fu (付洋洋), Tsinghua University (fuyangyang@tsinghua.edu.cn)

Yifei Sun (孙轶斐), Hainan University/Beihang University (sunif@buaa.edu.cn)

Zhaoquan Chen (陈兆权), Anhui University of Technology (chenzq@ahut.edu.cn)

Zhen Liu (刘振), Zhejiang University (Zliu@zju.edu.cn)

Xinpei Lu (卢新培), Huazhong University of Science and Technology (luxinpei@hotmail.com)

Zhiyuan Ning (宁致远), Yunnan University (Zhiyuan_Ning@outlook.com)

Jinhai Niu (牛金海), Dalian Minzu University (niujh@dlmu.edu.cn)

Jiayi Wang (王嘉一), Xinjiang University (nonthermal_jyw@163.com)

Wenzheng Liu (刘文正), Beijing Jiaotong University (wzhliu@bjtu.edu.cn)

Qiuyue Nie (聂秋月), Harbin Institute of Technology (nieqiuyue@hit.edu.cn)

Dezheng Yang (杨德正), Dalian University of Technology (yangdz@dlut.edu.cn)

Wei Tian (田微), South-Central Minzu University (victor-tian888@163.com)

Dong Dai (戴栋), South China University of Technology (ddai@scut.edu.cn)

Xiaolong Wang (王晓龙), Shandong University (wangxiaolong@sdu.edu.cn)

Zhongwei Liu (刘忠伟), Beijing Institute of Graphic Communication (liuzhongwei@bigc.edu.cn)

Xuechen Li (李雪辰), Hebei University (plasmalab@126.com)

Yangfang Li (李阳芳), Southwestern Institute of Physics (liyangfang@swip.ac.cn)

Jinglin Wan (万京林), Nanjing Suman Co., Ltd (coronalab@coronalab.net)